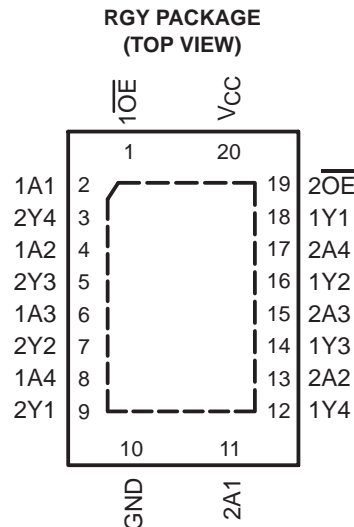


# SN74AUC240

## OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

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- Optimized for 1.8-V Operation and is 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Sub 1-V Operable
- Max  $t_{pd}$  of 1.7 ns at 1.8 V
- Low Power Consumption, 20- $\mu$ A Max  $I_{CC}$
- $\pm 8$ -mA Output Drive at 1.8 V
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



### description/ordering information

This octal buffer/driver is operational at 0.8-V to 2.7-V  $V_{CC}$ , but is designed specifically for 1.65-V to 1.95-V  $V_{CC}$  operation.

The SN74AUC240 is designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

This device is organized as two 4-bit buffers/drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

### ORDERING INFORMATION

| $T_A$         | PACKAGE†  |               | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|---------------|-----------|---------------|--------------------------|---------------------|
| -40°C to 85°C | QFN – RGY | Tape and reel | SN74AUC240RGYR           | MS240               |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

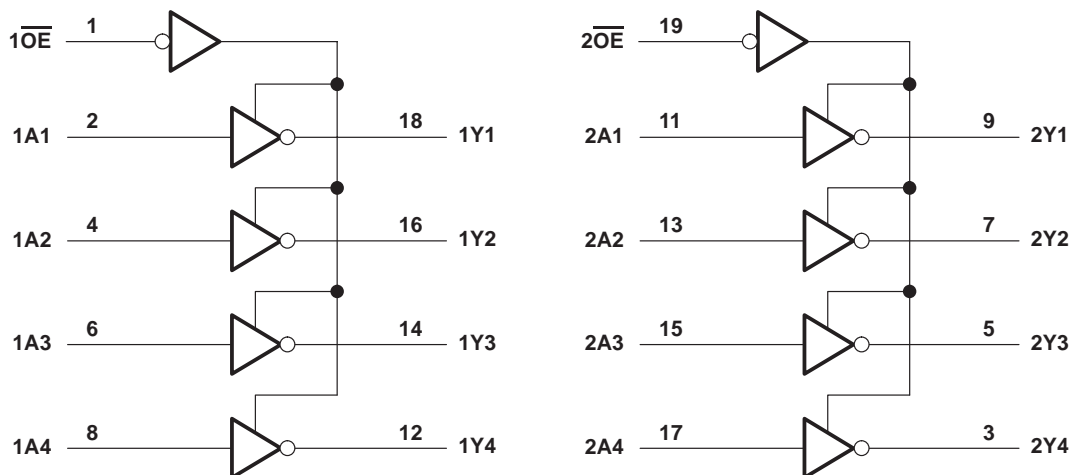
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

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**FUNCTION TABLE**  
(each 4-bit buffer/driver)

| INPUTS          |   | OUTPUT |
|-----------------|---|--------|
| $\overline{OE}$ | A | Y      |
| L               | H | L      |
| L               | L | H      |
| H               | X | Z      |

**logic diagram (positive logic)**



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

|  |                            |
|--|----------------------------|
| Supply voltage range, $V_{CC}$   | –0.5 V to 3.6 V            |
| Input voltage range, $V_I$ (see Note 1)  | –0.5 V to 3.6 V            |
| Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) | –0.5 V to 3.6 V            |
| Output voltage range, $V_O$ (see Note 1)   | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )  | –50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )   | –50 mA                     |
| Continuous output current, $I_O$   | $\pm 20$ mA                |
| Continuous current through $V_{CC}$ or GND   | $\pm 100$ mA               |
| Package thermal impedance, $\theta_{JA}$ (see Note 2)  | 37°C/W                     |
| Storage temperature range, $T_{stg}$   | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-5.

**SN74AUC240**  
**OCTAL BUFFER/DRIVER**  
**WITH 3-STATE OUTPUTS**

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**recommended operating conditions (see Note 3)**

|                 |                                    |                                   | MIN                    | MAX             | UNIT |
|-----------------|------------------------------------|-----------------------------------|------------------------|-----------------|------|
| V <sub>CC</sub> | Supply voltage                     |                                   | 0.8                    | 2.7             | V    |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 0.8 V           | V <sub>CC</sub>        |                 | V    |
|                 |                                    | V <sub>CC</sub> = 1.1 V to 1.95 V | 0.65 × V <sub>CC</sub> |                 |      |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V  | 1.7                    |                 |      |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 0.8 V           | 0                      |                 | V    |
|                 |                                    | V <sub>CC</sub> = 1.1 V to 1.95 V | 0.35 × V <sub>CC</sub> |                 |      |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V  | 0.7                    |                 |      |
| V <sub>I</sub>  | Input voltage                      |                                   | 0                      | 3.6             | V    |
| V <sub>O</sub>  | Output voltage                     | Active state                      | 0                      | V <sub>CC</sub> | V    |
|                 |                                    | 3-state                           | 0                      | 3.6             |      |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 0.8 V           | −0.7                   |                 | mA   |
|                 |                                    | V <sub>CC</sub> = 1.1 V           | −3                     |                 |      |
|                 |                                    | V <sub>CC</sub> = 1.4 V           | −5                     |                 |      |
|                 |                                    | V <sub>CC</sub> = 1.65 V          | −8                     |                 |      |
|                 |                                    | V <sub>CC</sub> = 2.3 V           | −9                     |                 |      |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 0.8 V           | 0.7                    |                 | mA   |
|                 |                                    | V <sub>CC</sub> = 1.1 V           | 3                      |                 |      |
|                 |                                    | V <sub>CC</sub> = 1.4 V           | 5                      |                 |      |
|                 |                                    | V <sub>CC</sub> = 1.65 V          | 8                      |                 |      |
|                 |                                    | V <sub>CC</sub> = 2.3 V           | 9                      |                 |      |
| Δt/Δv           | Input transition rise or fall rate |                                   | 20                     |                 | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     |                                   | −40                    | 85              | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        |                                     | TEST CONDITIONS   | V <sub>CC</sub> | MIN                  | TYP† | MAX | UNIT |
|------------------|-------------------------------------|---|-----------------|----------------------|------|-----|------|
| V <sub>OH</sub>  |                                     | I <sub>OH</sub> = -100 µA                                   | 0.8 V to 2.7 V  | V <sub>CC</sub> -0.1 |      |     | V    |
|                  |                                     | I <sub>OH</sub> = -0.7 mA                                   | 0.8 V           | 0.55                 |      |     |      |
|                  |                                     | I <sub>OH</sub> = -3 mA                                     | 1.1 V           | 0.8                  |      |     |      |
|                  |                                     | I <sub>OH</sub> = -5 mA                                     | 1.4 V           | 1                    |      |     |      |
|                  |                                     | I <sub>OH</sub> = -8 mA                                     | 1.65 V          | 1.2                  |      |     |      |
|                  |                                     | I <sub>OH</sub> = -9 mA                                     | 2.3 V           | 1.8                  |      |     |      |
| V <sub>OL</sub>  |                                     | I <sub>OL</sub> = 100 µA                                    | 0.8 V to 2.7 V  | 0.2                  |      |     | V    |
|                  |                                     | I <sub>OL</sub> = 0.7 mA                                    | 0.8 V           | 0.25                 |      |     |      |
|                  |                                     | I <sub>OL</sub> = 3 mA                                      | 1.1 V           | 0.3                  |      |     |      |
|                  |                                     | I <sub>OL</sub> = 5 mA                                      | 1.4 V           | 0.4                  |      |     |      |
|                  |                                     | I <sub>OL</sub> = 8 mA                                      | 1.65 V          | 0.45                 |      |     |      |
|                  |                                     | I <sub>OL</sub> = 9 mA                                      | 2.3 V           | 0.6                  |      |     |      |
| I <sub>I</sub>   | A and $\overline{\text{OE}}$ inputs | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 0 to 2.7 V      |                      |      | ±5  | µA   |
| I <sub>off</sub> |                                     | V <sub>I</sub> or V <sub>O</sub> = 2.7 V                    | 0               |                      |      | ±10 | µA   |
| I <sub>OZ</sub>  |                                     | V <sub>O</sub> = V <sub>CC</sub> or GND                     | 2.7 V           |                      |      | ±10 | µA   |
| I <sub>CC</sub>  |                                     | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | 0.8 V to 2.7 V  |                      |      | 20  | µA   |
| C <sub>i</sub>   |                                     | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 2.5 V           | 2.5                  |      | 3   | pF   |
| C <sub>o</sub>   |                                     | V <sub>O</sub> = V <sub>CC</sub> or GND                     | 2.5 V           | 5.5                  |      | 6   | pF   |

† All typical values are at T<sub>A</sub> = 25°C.

switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 15 pF (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM (INPUT)           | TO (OUTPUT) | V <sub>CC</sub> = 0.8 V | V <sub>CC</sub> = 1.2 V ± 0.1 V |     | V <sub>CC</sub> = 1.5 V ± 0.1 V |     | V <sub>CC</sub> = 1.8 V ± 0.15 V |     |     | V <sub>CC</sub> = 2.5 V ± 0.2 V |     | UNIT |
|------------------|------------------------|-------------|-------------------------|---------------------------------|-----|---------------------------------|-----|----------------------------------|-----|-----|---------------------------------|-----|------|
|                  |                        |             | TYP                     | MIN                             | MAX | MIN                             | MAX | MIN                              | TYP | MAX | MIN                             | MAX |      |
| t <sub>pd</sub>  | A                      | Y           | 4.8                     | 1.2                             | 3.3 | 0.8                             | 2   | 0.7                              | 1.1 | 1.7 | 0.6                             | 1.3 | ns   |
| t <sub>en</sub>  | $\overline{\text{OE}}$ | Y           | 6.4                     | 1.4                             | 4   | 0.9                             | 2.6 | 0.8                              | 1.2 | 2.1 | 0.7                             | 1.5 | ns   |
| t <sub>dis</sub> | $\overline{\text{OE}}$ | Y           | 8.7                     | 2                               | 5.8 | 1.8                             | 3.9 | 1.8                              | 2.5 | 4   | 0.3                             | 3   | ns   |

switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 30 pF (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM (INPUT)           | TO (OUTPUT) | V <sub>CC</sub> = 1.8 V ± 0.15 V |     |     | V <sub>CC</sub> = 2.5 V ± 0.2 V |     | UNIT |
|------------------|------------------------|-------------|----------------------------------|-----|-----|---------------------------------|-----|------|
|                  |                        |             | MIN                              | TYP | MAX | MIN                             | MAX |      |
| t <sub>pd</sub>  | A                      | Y           | 1                                | 1.4 | 2.1 | 0.9                             | 1.6 | ns   |
| t <sub>en</sub>  | $\overline{\text{OE}}$ | Y           | 1.1                              | 1.7 | 2.7 | 1                               | 2   | ns   |
| t <sub>dis</sub> | $\overline{\text{OE}}$ | Y           | 1.9                              | 2.5 | 4   | 1                               | 2   | ns   |

**SN74AUC240**  
**OCTAL BUFFER/DRIVER**  
**WITH 3-STATE OUTPUTS**

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operating characteristics,  $T_A = 25^\circ\text{C}$

| PARAMETER                              |                  | TEST CONDITIONS     | $V_{CC} = 0.8\text{ V}$ | $V_{CC} = 1.2\text{ V}$ | $V_{CC} = 1.5\text{ V}$ | $V_{CC} = 1.8\text{ V}$ | $V_{CC} = 2.5\text{ V}$ | UNIT          |
|--|------------------|---------------------|-------------------------|-------------------------|-------------------------|-------------------------|-------------------------|---------------|
|  |                  |                     | TYP                     | TYP                     | TYP                     | TYP                     | TYP                     |               |
| $C_{pd}$ Power dissipation capacitance | Outputs enabled  | $f = 10\text{ MHz}$ | 21                      | 21                      | 21                      | 22                      | 25                      | $\mu\text{F}$ |
|  | Outputs disabled |                     | 3                       | 3                       | 3                       | 3                       | 5                       |               |



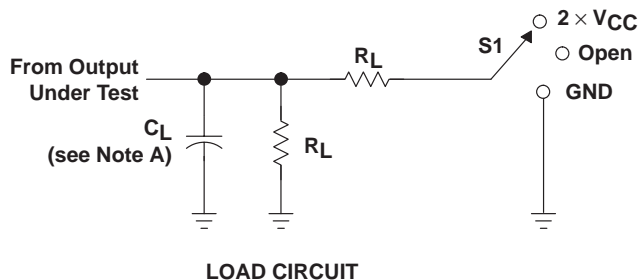
# SN74AUC240

## OCTAL BUFFER/DRIVER

### WITH 3-STATE OUTPUTS

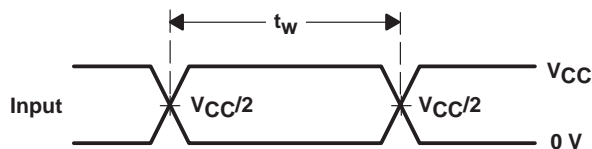
SCES430A – MARCH 2003 – REVISED MARCH 2003

#### PARAMETER MEASUREMENT INFORMATION

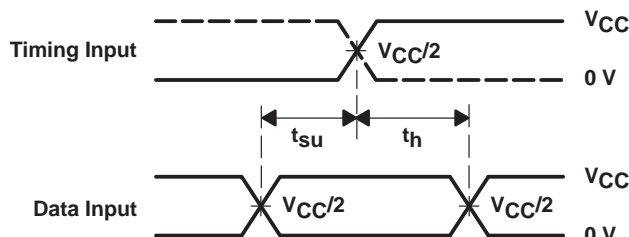


| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLH}/t_{PHL}$ | Open              |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |

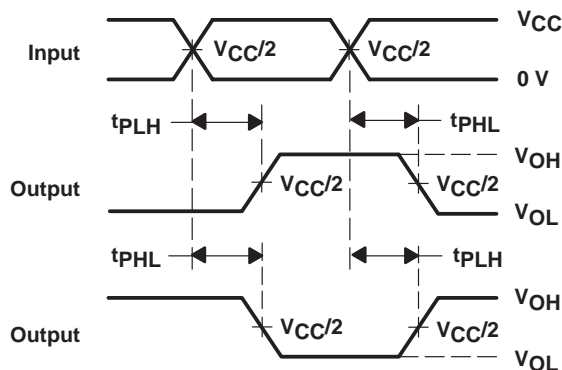
| $V_{CC}$           | $C_L$ | $R_L$        | $V_{\Delta}$ |
|--------------------|-------|--------------|--------------|
| 0.8 V              | 15 pF | 2 k $\Omega$ | 0.1 V        |
| 1.2 V $\pm$ 0.1 V  | 15 pF | 2 k $\Omega$ | 0.1 V        |
| 1.5 V $\pm$ 0.1 V  | 15 pF | 2 k $\Omega$ | 0.1 V        |
| 1.8 V $\pm$ 0.15 V | 15 pF | 2 k $\Omega$ | 0.15 V       |
| 2.5 V $\pm$ 0.2 V  | 15 pF | 2 k $\Omega$ | 0.15 V       |
| 1.8 V $\pm$ 0.15 V | 30 pF | 1 k $\Omega$ | 0.15 V       |
| 2.5 V $\pm$ 0.2 V  | 30 pF | 500 $\Omega$ | 0.15 V       |



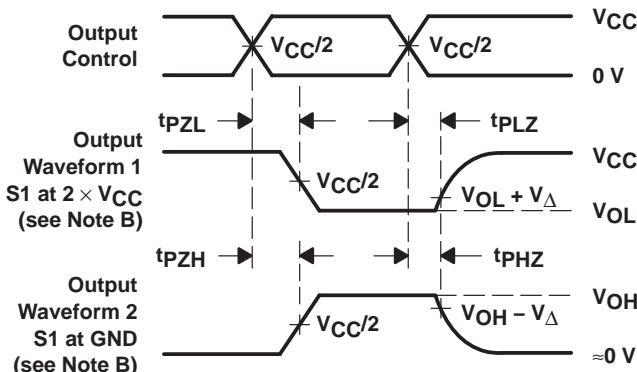
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ , slew rate  $\geq 1 \text{ V/ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN74AUC240RGYR</a> | Active        | Production           | VQFN (RGY)   20 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MS240               |
| SN74AUC240RGYR.B               | Active        | Production           | VQFN (RGY)   20 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MS240               |
| SN74AUC240RGYRG4               | Active        | Production           | VQFN (RGY)   20 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MS240               |
| SN74AUC240RGYRG4.B             | Active        | Production           | VQFN (RGY)   20 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MS240               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AUC240RGYR   | VQFN         | RGY             | 20   | 3000 | 330.0              | 12.4               | 3.71    | 4.71    | 1.1     | 8.0     | 12.0   | Q1            |
| SN74AUC240RGYRG4 | VQFN         | RGY             | 20   | 3000 | 330.0              | 12.4               | 3.71    | 4.71    | 1.1     | 8.0     | 12.0   | Q1            |



## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AUC240RGYR   | VQFN         | RGY             | 20   | 3000 | 353.0       | 353.0      | 32.0        |
| SN74AUC240RGYRG4 | VQFN         | RGY             | 20   | 3000 | 353.0       | 353.0      | 32.0        |

## GENERIC PACKAGE VIEW

**RGY 20**

**VQFN - 1 mm max height**

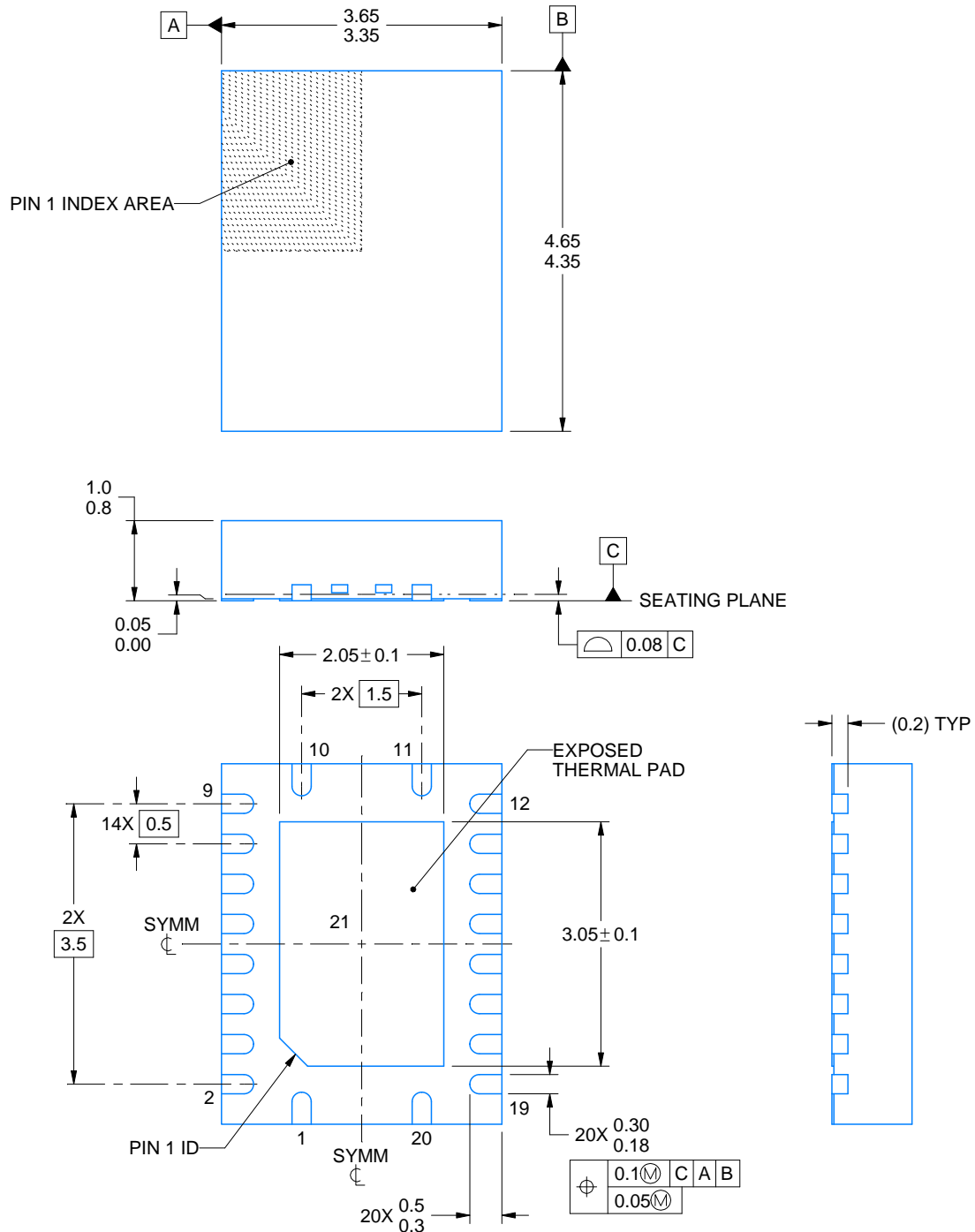
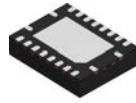
3.5 x 4.5, 0.5 mm pitch

PLASTIC QUAD FGLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4225264/A



4225320/A 09/2019

NOTES:

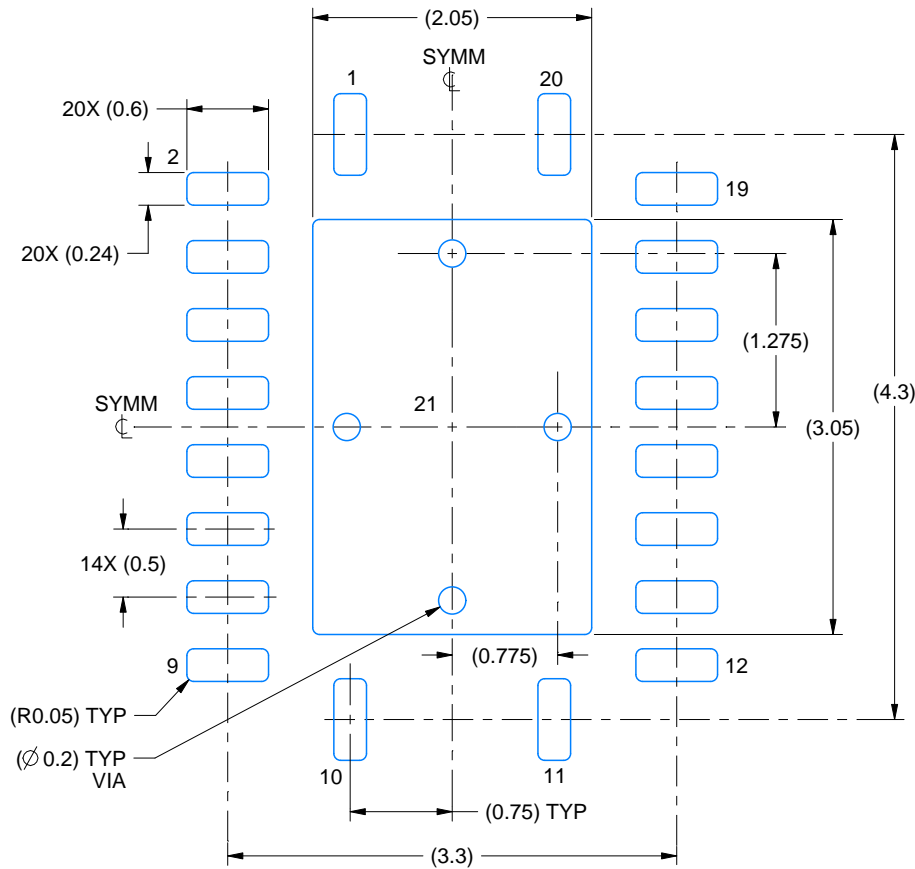
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

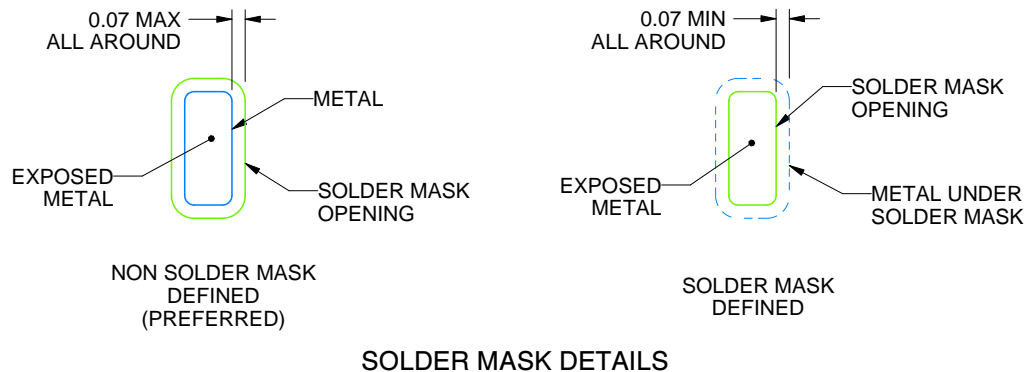
RGY0020A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:18X



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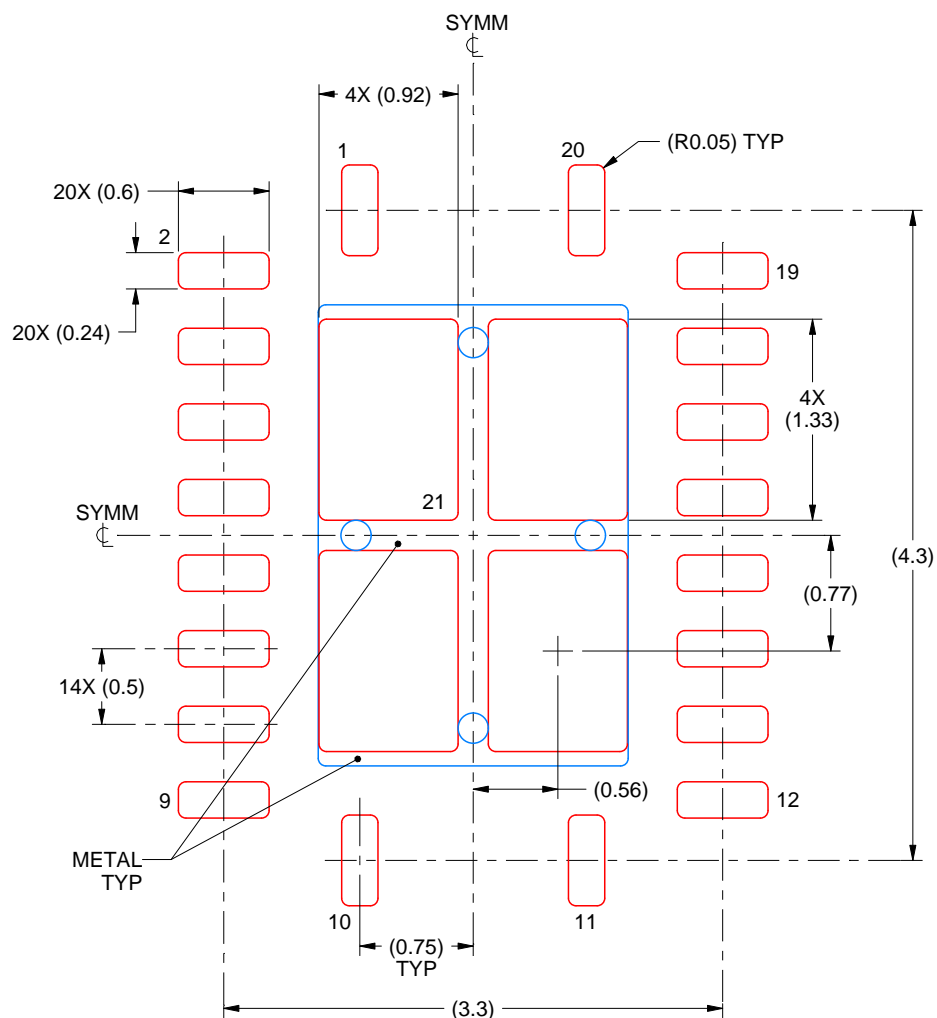
NOTES: (continued)

- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

**RGY0020A**

### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
**BASED ON 0.125 mm THICK STENCIL**

EXPOSED PAD 21  
78% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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